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NC7WZU04

TinyLogic® UHS Dual Unbuffered Inverter

Features


- Space saving SC70 6-lead package
- Ultra small MicroPak™ leadless package
- Unbuffered for crystal oscillator and analog applications
- Balanced output drive: $\pm 8\text{mA}$ at $4.5\text{V } V_{CC}$
- Broad V_{CC} operating range: 1.65V to 5.5V
- Low quiescent power: $I_{CC} < 1\mu\text{A}$ at $5\text{V } V_{CC}$, $T_A = 25^\circ\text{C}$

General Description

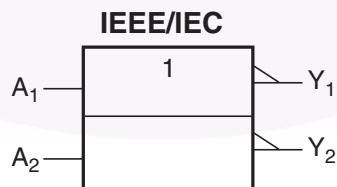
The NC7WZU04 is a dual unbuffered inverter from Fairchild's Ultra High Speed Series of TinyLogic® in the space saving SC70 6-lead package. The special purpose unbuffered circuit design is intended for crystal oscillator or analog applications. The internal circuit consists of only one-stage, the output, to allow for this part to be used in these oscillator or analog applications. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65V to $5.5\text{V } V_{CC}$ range. The inputs are high impedance when V_{CC} is 0V . Inputs tolerate voltages up to 7V independent of V_{CC} operating voltage.

Ordering Information

Order Number	Package Number	Package Code Top Mark	Package Description	Supplied As
NC7WZU04P6X	MAA06A	ZU4	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel
NC7WZU04L6X	MAC06A	B5	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

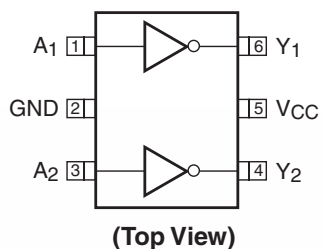
 All packages are lead free per JEDEC: J-STD-020B standard.

Logic Symbol

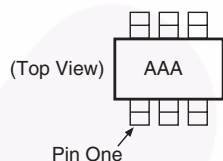


Connection Diagrams

Pin Assignment for SC70



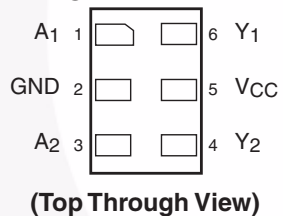
Pin One Orientation Diagram



AAA represents Product Code Top Mark – see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



Pin Descriptions

Pin Name	Description
A ₁ , A ₂	Data Inputs
Y ₁ , Y ₂	Outputs

Function Table

$$Y = \bar{A}$$

Input	Output
A	Y
L	H
H	L

H = HIGH Logic Level
L = LOW Logic Level



Absolute Maximum Ratings

The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table will define the conditions for actual device operation.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	-0.5V to +7V
V_{IN}	DC Input Voltage	-0.5V to +7V
V_{OUT}	DC Output Voltage	-0.5V to +7V
I_{IK}	DC Input Diode Current @ $V_{IN} \leq -0.5V$	-50mA
I_{OK}	DC Output Diode Current @ $V_{OUT} < -0.5V$ $V_{OUT} > 0.5V, V_{CC} = GND$	-50mA +50mA
I_{OUT}	DC Output Current	$\pm 50mA$
I_{CC}/I_{GND}	DC V_{CC}/GND Current	$\pm 100mA$
T_{STG}	Storage Temperature	-65°C to +150°C
T_J	Junction Temperature under Bias	150°C
T_L	Junction Lead Temperature (Soldering, 10 seconds)	260°C
P_D	Power Dissipation @ +85°C SC70-6 Micropak-6	215mW 215mW

Recommended Operating Conditions⁽¹⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage Operating	1.8V to 5.5V
V_{CC}	Supply Voltage Data Retention	1.5V to 5.5V
V_{IN}	Input Voltage	0V to 5.5V
V_{OUT}	Output Voltage	0V to V_{CC}
T_A	Operating Temperature	-40°C to +85°C
θ_{JA}	Thermal Resistance SC70-6 Micropak-6	350°C/W 350°C/W

Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions		T _A =					Units		
					+25°C			-40°C to +85°C				
					Min .	Typ.	Max .	Min.	Max.			
V _{IH}	HIGH Level Input Voltage	1.8 to 2.7			0.85 V _{CC}			0.85 V _{CC}		V		
		3.0 to 5.5			0.8 V _{CC}			0.8 V _{CC}				
V _{IL}	LOW Level Input Voltage	1.8 to 2.7						0.15 V _{CC}		V		
		3.0 to 5.5						0.2 V _{CC}				
V _{OH}	HIGH Level Output Voltage	1.65	V _{IN} = V _{IL}	I _{OH} = -100μA	1.55	1.65		1.55		V		
		1.8			1.6	1.79		1.6				
		2.3			2.1	2.29		2.1				
		3.0			2.7	2.99		2.7				
		4.5			4.0	4.48		4.0				
			1.65	V _{IN} = GND	I _{OH} = -2mA	1.29	1.52		1.29		V	
			2.3			I _{OH} = -2mA	1.9	2.19		1.9		
			3.0			I _{OH} = -4mA	2.4	2.82		2.4		
			3.0			I _{OH} = -6mA	2.3	2.73		2.3		
			4.5			I _{OH} = -8mA	3.8	4.24		3.8		
VOL	LOW Level Output Voltage	1.65	V _{IN} = V _{IH}	I _{OL} = 100μA		0.01	0.2		0.2	V		
		1.8				0.01	0.2		0.2			
		2.3				0.01	0.2		0.2			
		3.0				0.01	0.3		0.3			
		4.5				0.01	0.5		0.5			
			1.65	V _{IN} = V _{CC}	I _{OL} = 2mA		0.10	0.24		0.24	V	
			2.3			I _{OL} = 2mA		0.12	0.3			0.3
			3.0			I _{OL} = 4mA		0.19	0.4			0.4
			3.0			I _{OL} = 6mA		0.29	0.55			0.55
			4.5			I _{OL} = 8mA		0.29	0.55			0.55
I _{IN}	Input Leakage Current	0 to 5.5	V _{IN} = 5.5V, GND				±0.1		±1.0	μA		
I _{CC}	Quiescent Supply Current	1.65 to 5.5	V _{IN} = 5.5V, GND				1.0		10	μA		
I _{CCPEAK}	Peak Supply Current in Analog Operation	1.8	V _{OUT} = Open V _{IN} = Adjust for Peak I _{CC} Current			0.2				mA		
		2.5				2						
		3.3				5						
		5.0				15						

AC Electrical Characteristics

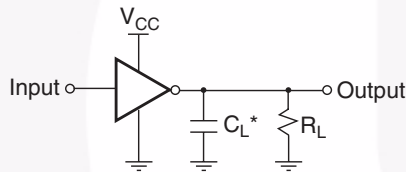
Symbol	Parameter	V _{CC} (V)	Conditions	T _A =					Units	Figure Number
				+25°C			-40°C to +85°C			
				Min.	Typ.	Max.	Min.	Max.		
t _{PLH} , t _{PHL}	Propagation Delay	1.65	C _L = 15pF, R _L = 1MΩ	1.5	5.5	9.8	1.5	11.0	ns	Figure 1 Figure 3
		1.8		1.5	4.6	8.1	1.5	8.9		
		2.5 ± 0.2		1.2	3.3	5.7	1.2	6.3		
		3.3 ± 0.3		0.8	2.7	4.1	0.8	4.5		
		5.0 ± 0.5		0.5	2.2	3.3	0.5	3.6		
		3.3 ± 0.3		C _L = 50pF, R _L = 500Ω,	1.2	4.0	6.4	1.2		
5.0 ± 0.5	0.8	3.4	5.6		0.8	6.2				
C _{IN}	Input Capacitance	0			3				pF	
C _{PD}	Power Dissipation Capacitance	3.3	Note 2		3.5				pF	Figure 2
		5.0			5.5					

Note:

2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression:

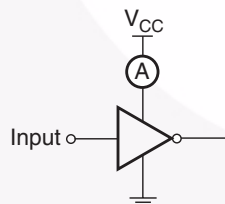
$$I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CCstatic}).$$

AC Loading and Waveforms



*C_L includes load and stray capacitance.
Input PRR = 1.0MHz; t_w = 500ns

Figure 1. AC Test Circuit



Application Note: When operating the NC7WZU04's unbuffered output stage in its linear range, as in oscillator applications, care must be taken to observe maximum power rating for the device and package. The high drive nature of the design of the output stage will result in substantial simultaneous conduction currents when the stage is in the linear region. See the I_{CCPEAK} specification on page 2.

Input = AC Waveform; t_r, t_f = 1.8ns;
PRR = 10MHz; Duty Cycle = 50%

Figure 2. I_{CCD} Test Circuit

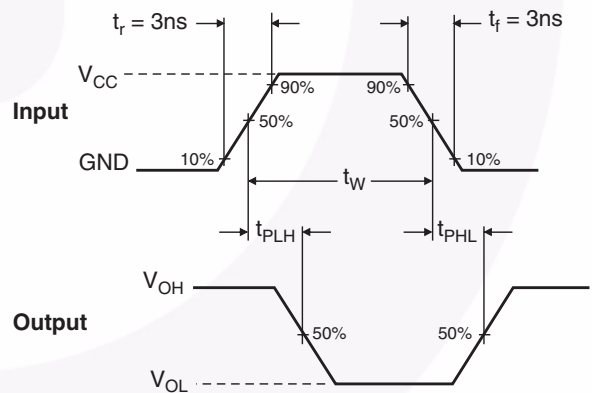


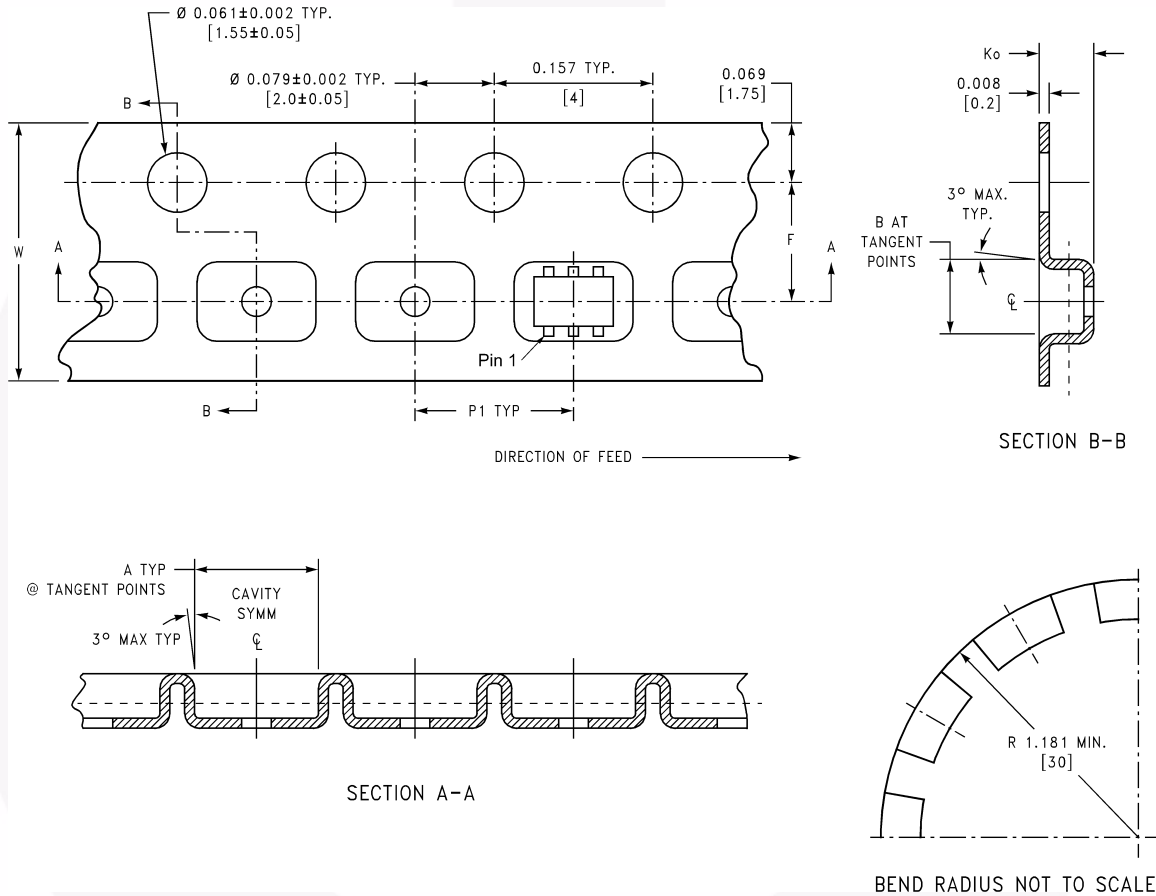
Figure 3. AC Waveforms

Tape and Reel Specification

Tape Format for SC70

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
P6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

Tape Dimension inches (millimeters)



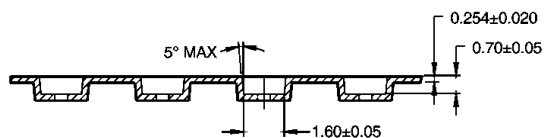
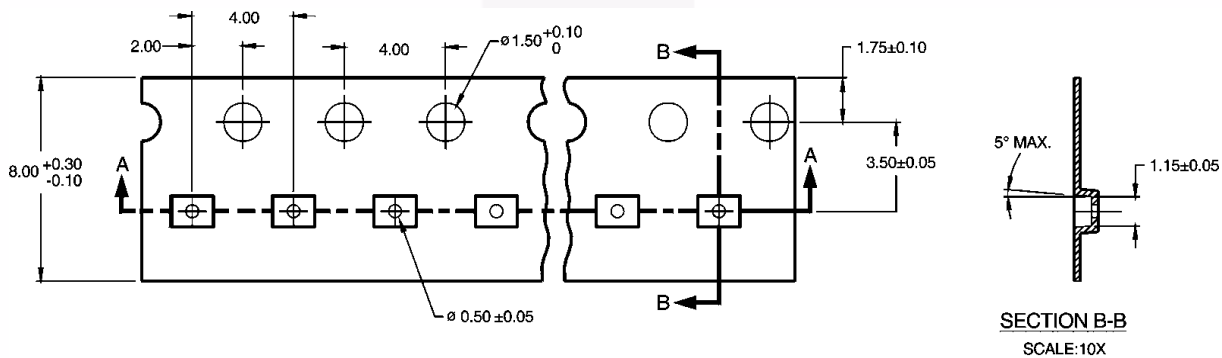
Package	Tape Size	Dim A	Dim B	Dim F	Dim K _O	Dim P1	Dim W
SC70-6	8mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)

Tape and Reel Specification (Continued)

Tape Format for MicroPak

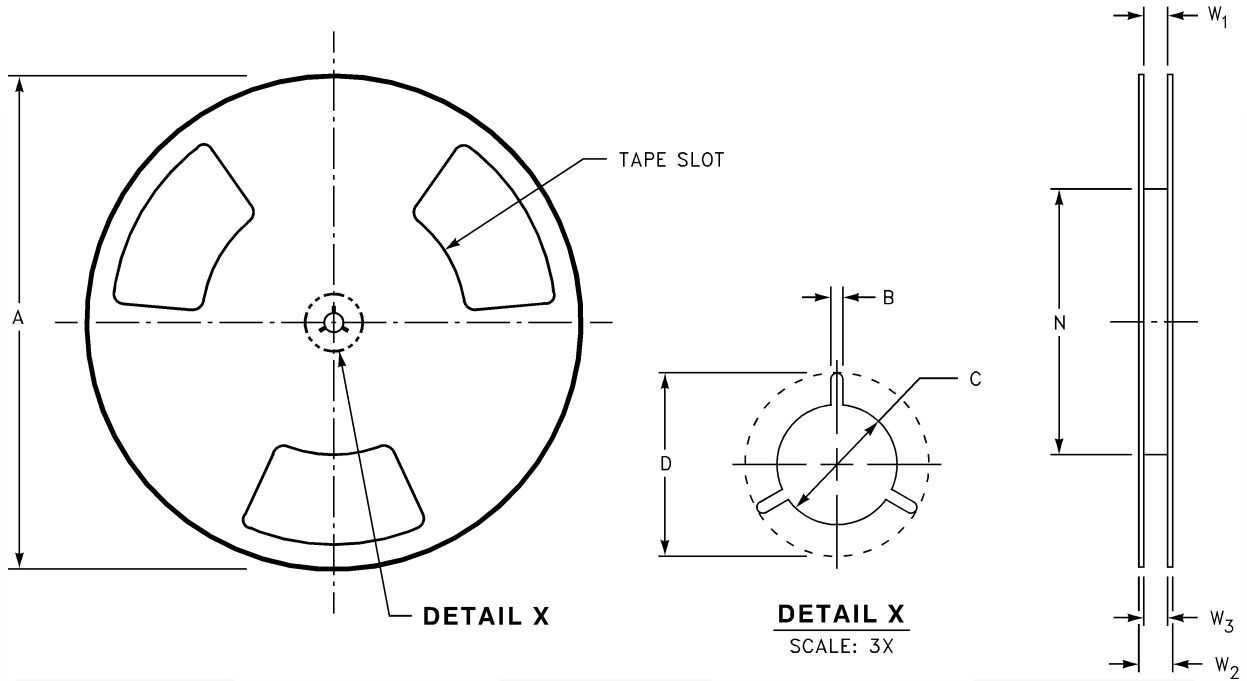
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

Tape Dimension inches (millimeters)



Tape and Reel Specification (Continued)

Reel Dimension for MicroPak inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2	W3
8mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00)	0.567 (14.40)	W1 + 0.078/-0.039 (W1 + 2.00/-1.00)

Physical Dimensions

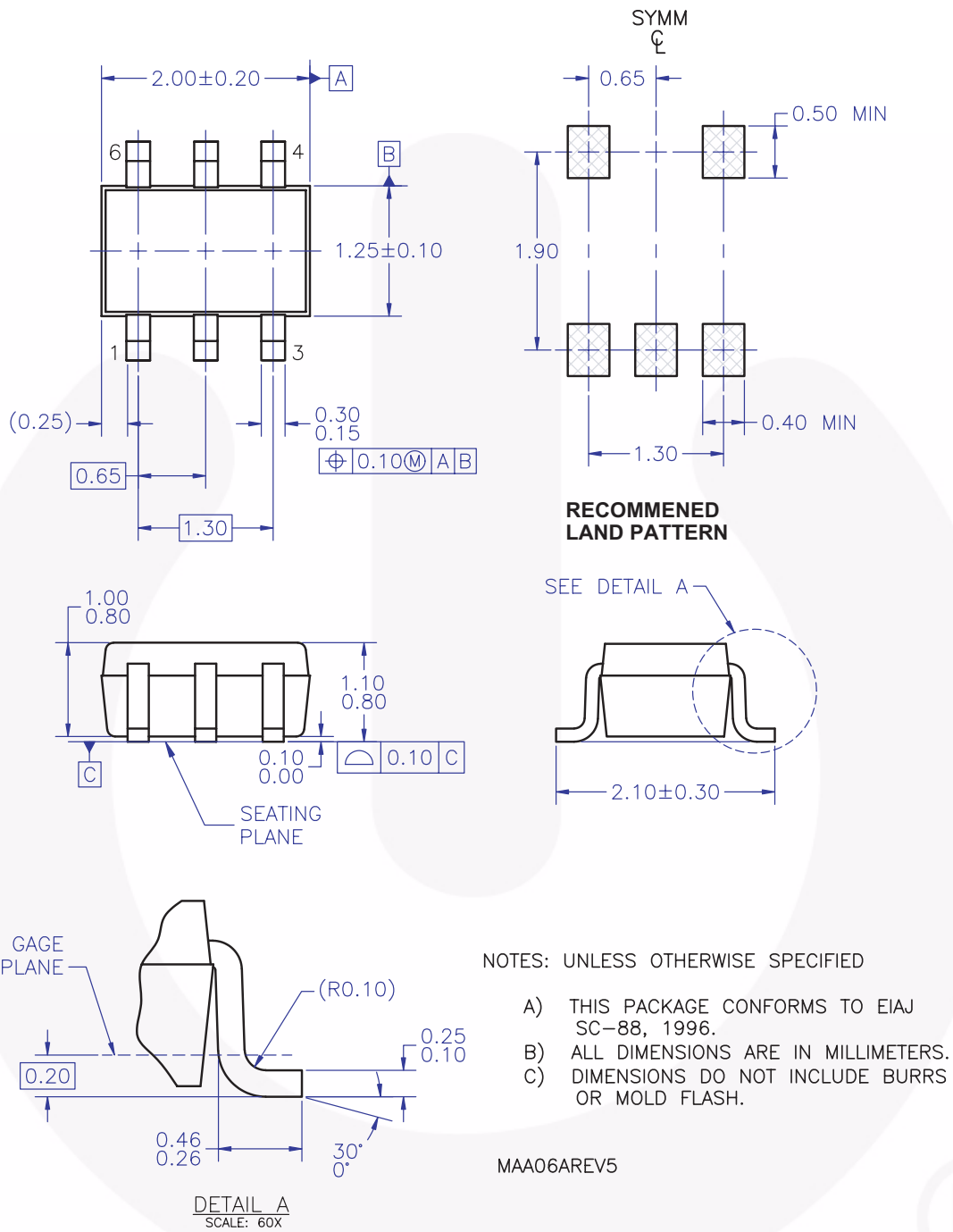


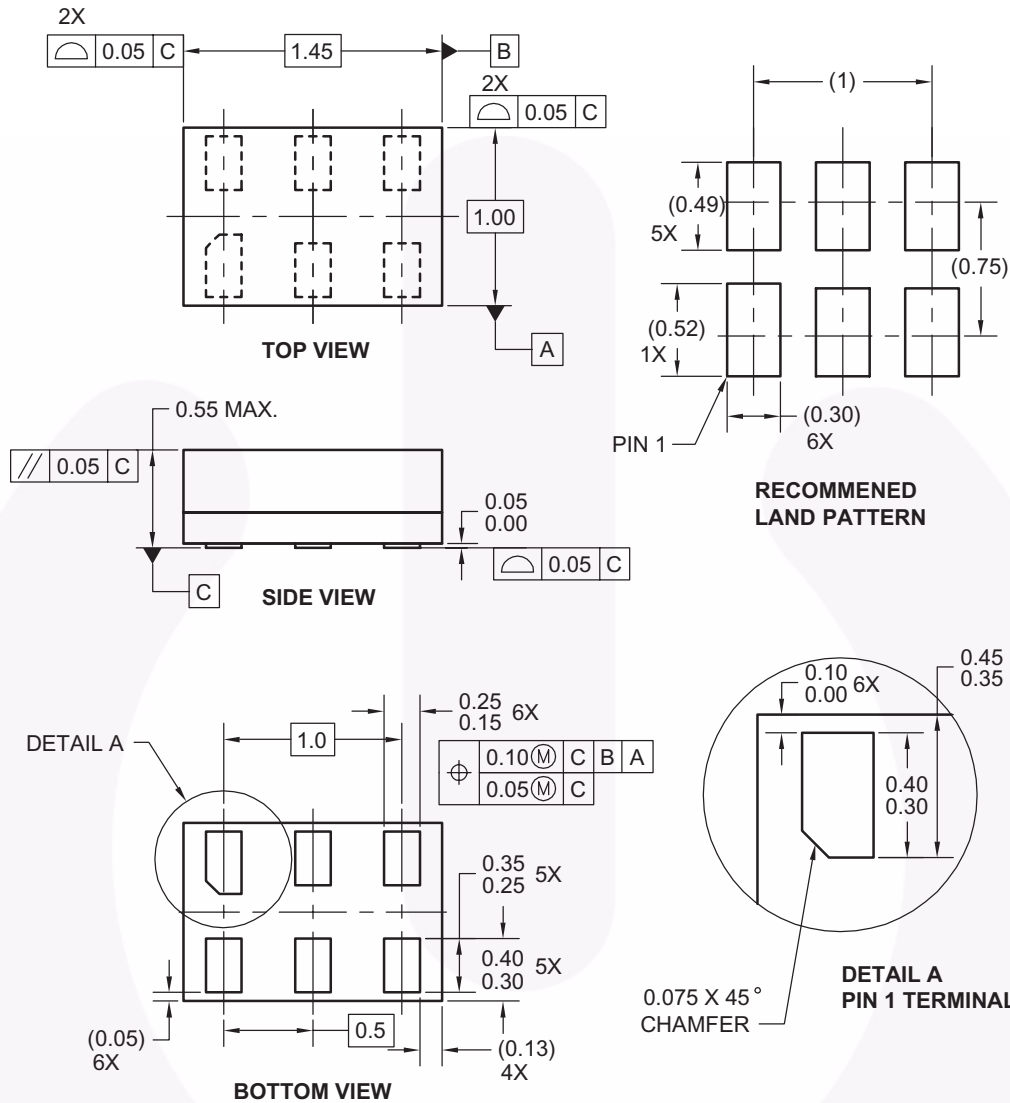
Figure 4. 6-Lead SC70, EIAJ SC88, 1.25mm Wide

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Physical Dimensions (Continued)



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06AREVC

Figure 5. 6-Lead MicroPak, 1.0mm Wide

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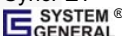
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